

半導体製造装置向けパーツ

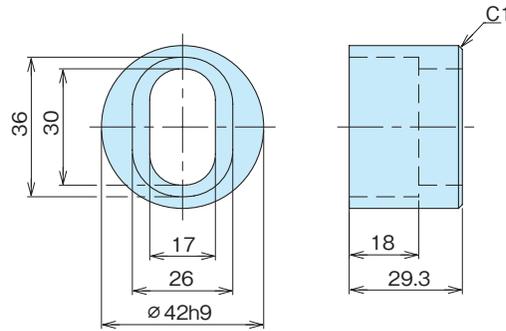
SEMICONDUCTOR EQUIPMENT RELATED PARTS



Y-30-14~17



Y-30-14



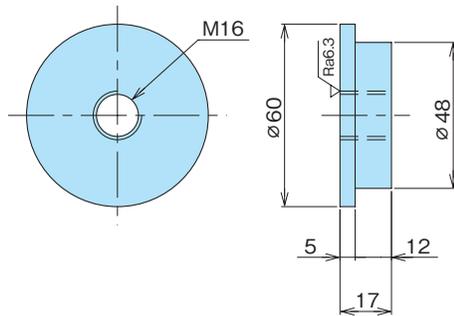
特徴
Feature

- 高度な技術を生かした切削加工は、精密さが要求される半導体装置、医療機器、電子部品といった分野にも用いられています。
- 高い精度で様々な形が作り出せ、金型等での制作に比べて、低コストで多品種・少量生産に対応します。
- その他各種形状・材質にも対応しますので、お問合せ下さい。

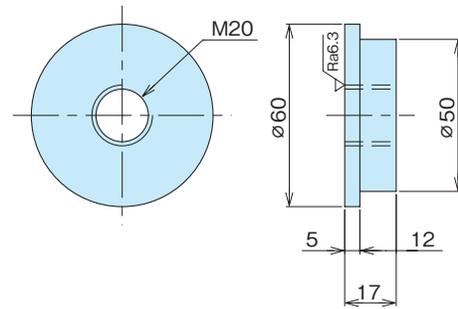
- Advanced technology is used for processing in fields that require precision, such as semiconductor devices, medical equipment, and electronic components.
- High-precision products can be produced at low cost compared to production with molds, etc., and can be used for high-mix, low-volume production.
- Other shapes and materials are also available, so please contact us.



Y-30-15



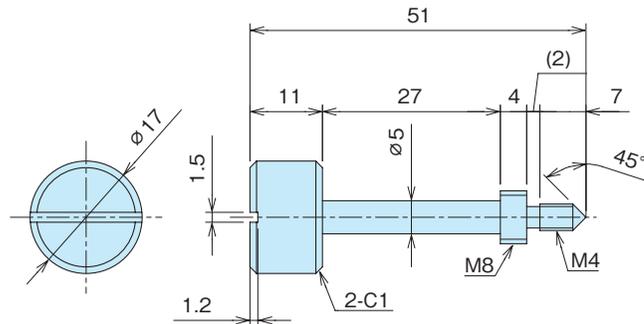
Y-30-15



Y-30-16



SY-30-17



半導体装置関連パーツ

品番 Product No.	材質	自重(g) Weight	単価 Price
Y-30-14	SS400	180	¥1,250
Y-30-15	SS400	256	¥1,400
Y-30-16	SS400	256	¥1,400
SY-30-17	SUS304	24	¥2,100